

Features

- Low Supply Current~55uA (Typ.)
- Low Shutdown Current ~0.1uA (Typ.)
- Output Current ~300mA
- High Power Supply Rejection Ratio
 ~75dB@1KHz
- 1.7~5.5V Operation
- ±1.5% Initial Voltage Accuracy
- Low Temperature Drift Coefficient ~50ppm
- Line Regulation ~0.02%/V(Typ.)
- Low ESR Capacitor ~1.0uF ceramic capacitor
- WDFN4-1.2x1.6 \ TDFN6-1.8x2 \ SOT-23-5 \ SOT-89-3 \ MSOT-23 and SOT-353 package
- Green Product (RoHS, Lead-Free, Halogen-Free Compliant)

Applications

- Portable communication equipment
- Notebook Computer
- Battery Powered Systems

General Description

The GS7119 is a CMOS linear regulator. It is featuring ultra-high power supply rejection ratio, low output voltage noise, low dropout voltage, low quiescent current and fast transient response. It guarantees delivery of 300mA output current, and supports preset 1.2V, 1.3V, 1.5V, 1.7V, 1.8V, 1.85V, 1.9V, 2.0V, 2.3V, 2.5V, 2.6V, 2.7V, 2.8V, 2.85V, 2.9V, 3.0V, 3.1V, 3.3V output voltage versions.

Based on its low quiescent current consumption and its less than 1uA shutdown mode, the GS7119 is ideal for battery- powered applications. The high power supply rejection ratio of the GS7119 holds well for low input voltages typically encountered in battery- operated systems. The regulator is stable with small ceramic capacitive loads (1µF typical).

Typical Application

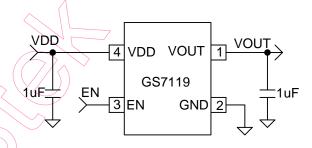


Figure 1 Typical Application of GS7119

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Function Block Diagram

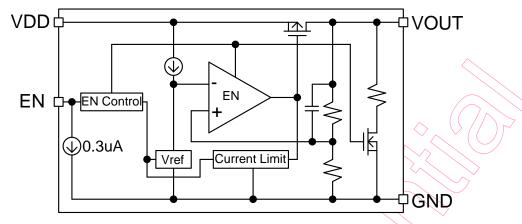


Figure 2a with auto discharge function (default)

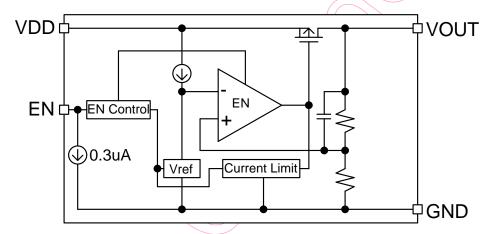


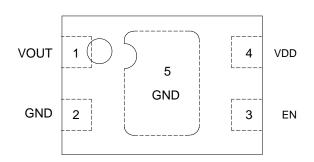
Figure 2b without auto discharge function (special order)

Figure 2 Function Block Diagram

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Pin Configuration



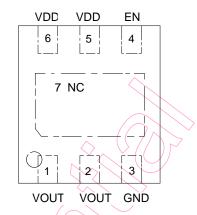
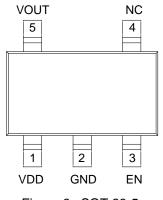
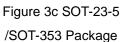


Figure 3a WDFN4-1.2x1.6 Package

Figure 3b TDFN6-1.8x2 package





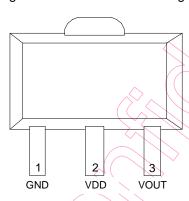


Figure 3d SOT-89-3 Package

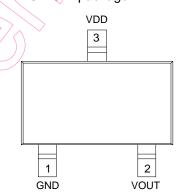


Figure 3e MSOT-23 Package

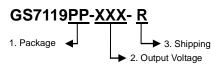
Pin Descriptions

		No					
WDFN4-1.2x1.6	TDFN6-1.8x2	SOT-23-5/ SOT-353	SOT-89-3	MSOT-23	Name	I/O type	Description
1	1, 2	((5/\)	3	2	VOUT	0	Output pin
2, 5	3	2	1	1	GND	0	Ground pin
3	4	3			EN	I	Enable Pin
4	5,6)) 1	2	3	VDD	I	Input Pin
	$\overline{2}$	4			NC		

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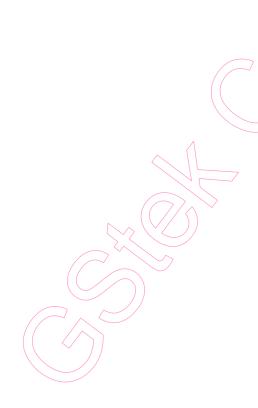


Ordering Information



No	Item	Contents
		UD: WDFN4-1.2x1.6
		TD: TDFN6-1.8x2
	1 Package	ST: SOT-23-5
1		S9: SOT-89-3
		SR: MSOT-23
		C5: SOT-353(SC-75)
		1P2: 1.2V, 1P3: 1.3V, 1P5: 1.5V, 1P7:1.7V, 1P8: 1.8V, 185: 1.85V, 1P9: 1.9V,
2	Output Voltage	2P0: 2.0V, 2P3: 2.3V, 2P5: 2.5V, 2P6: 2.6V, 2P7: 2.7V, 2P8: 2.8V, 285: 2.85V,
		2P9: 2.9V, 3P0: 3.0V, 3P1: 3.1V, 3P3: 3.3V
3	Shipping	R: Tape & Reel

Example: GS7119 2.5V SOT-23-5 Tape & Reel ordering information is "GS7119ST-2P5-R"



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Absolute Maximum Rating (Note 1)

Parameter	Symbol	Limits	Units
VIN to GND	V _{IN}	-0.3 < V _{IN} < 6	V
VEN to GND	V_{EN}	-0.3 < V _{EN} < 6	V
Output Voltage	V _{OUT}	$-0.3 < V_{OUT} < V_{IN} + 0.3$	V
Output Current	I _{OUT}	300	→ mA
Package Power Dissipation at T _A ≤25°C	P _{D_WDFN4-1.2x1.6}	500	mW
Package Power Dissipation at T _A ≤25°C	P _{D_TDFN6-1.8x2}	880	mW
Package Power Dissipation at T _A ≤25°C	P _{D_SOT-23-5}	420	mW
Package Power Dissipation at T _A ≤25°C	P _{D_SOT-89-3}	571	mW
Package Power Dissipation at T _A ≤25°C	P _{D_MSOT-23}	380	mW
Package Power Dissipation at T _A ≦25°C	P _{D_SOT-353}	300	mW
Storage Temperature	T _{STG}	- 65 ~ 150	°C
Lead Temperature (Soldering) 10S	TLEAD	260	°C
ESD (Human Body Mode) (Note 2)	V _{ESD_HBM}	2K	V
ESD (Machine Mode) (Note 2)	V _{ESD_MM}	200	V

Thermal Information (Note 3)

Parameter	Symbol	Limits	Units
Thermal Resistance Junction to Ambient	θ _{JA_WDFN4-1.2x1.6}	200	°C/W
Thermal Resistance Junction to Ambient	θ _{JA_TDFN6-1.8x2}	114	°C/W
Thermal Resistance Junction to Ambient	$\theta_{JA_SOT-23-5}$	238	°C/W
Thermal Resistance Junction to Ambient	$ heta_{JA_SOT-89-3}$	182	°C/W
Thermal Resistance Junction to Ambient	$\theta_{JA_MSOT-23}$	263	°C/W
Thermal Resistance Junction to Ambient	$\theta_{JA_SOT-353}$	333	°C/W

Recommend Operating Condition (Note 4)

Parameter	Symbol	Limits	Units
VIN to GND	V _{IN}	1.7 to 5.5	V
Junction Temperature	TJ	- 40 ~ 125	°C
Operating Temperature Range	T _A	-40 ~ 85	°C

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Electrical Characteristics

 $(V_{IN} = V_{OUT} + 1V, T_A = 25^{\circ}C, C_{IN} = C_L = 0.47 \mu F, I_{OUT} = 1 m A, unless otherwise specified)$

Parameter	Symbol	nbol Conditions		Min	Тур	Max	Units
SUPPLY VOLTAGE SECTION							
Supply Voltage	V _{IN}			1.7		5.5	V
Supply Current	I _{VIN}	Unload			55	70	uA
Standby Current	I _{STBY}	V _{EN} =0		\Diamond	0.1/	1,0	uA
EN Input Current	I _{EN}	$V_{EN}=V_{IN}=5.5V$			0.3		uA
Output Current(Note 5)	I _{OUT}			300 (Note 6)	?) /		mA
OUTPUT SECTION					7		
Output Voltage	V _{OUT}	T _A = 25°C		1.5		+1.5	%
		1 200 ··· A	V _{OUT} =1.2V		495	650	
		I _{OUT} =300mA	V _{OUT} =1.5V		375	490	- mV
		(For WDFN4-1.2x1.6, , SOT-23-5, SOT-89-3 package)	V _{OUT} =2.5V		235	295	
Dropout Voltage	V_{DROP}		V _{OUT} =2.8V		220	275	
(Note 7)			V _{OUT} =3.3V		195	245	
		1 200-	V _{OUT} =1.5V		500	680	
		I _{OUT} =300mA (For MSOT-23 package)	V _{OUT} =1.8V		400	490	
		(For MSO1-23 package)	V _{OUT} =2.8V		260	340	
Line Regulation	$\triangle V_{LNR}$	$V_{IN} = V_{OUT} + 0.5V \text{ to 5.5}$	/, I _{OUT} =1mA		0.02	0.20	%/V
Load Regulation	$\triangle V_{LDR}$	$V_{IN} = V_{OUT} + 1V$, $I_{OUT} = 1 \text{mA to } 150 \text{mA}$			15	40	mV
Ripple Rejection Rate	PSRR	V _{IN} =MAX{V _{OUT} +1.0V, 3V 0.2Vp-p, I _{OUT} =30mA, f=			78		dB
Limit Current	(llim/)	V _{EN} =V _{IN}			460		mA
Short Current	Ishort	V _{OUT} =0V			40		mA
EN Input Voltage High	V _{ENH}			1.2			V
EN Input Voltage Low	V _{ENL}					0.3	V
CL Auto-Discharge Resistance (Note 8)	Rdischg	V _{IN} =5.0V, V _{EN} =0V			95		Ω
Temperature Drift	$\triangle V_{OUT} / \triangle T_A$	I_{OUT} =1mA, $T_A = -40$ °C to +85°C			40		ppm/°C

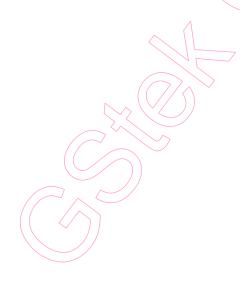
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Thermal Shutdown	Т	T _J Rising	165	°C
Temperature	I _{SD}	1) Kisiliy	100	
Thermal Shutdown			115	°C
Returned Temperature			145	°C

- **Note 1.** Stresses listed as the above "Absolute Maximum Ratings" may cause permanent damage to the device. These are for stress ratings. Functional operation of the device at these or any other conditions beyond those indicated in the operational sections of the specifications is not implied. Exposure to absolute maximum rating conditions for extended periods may remain possibility to affect device reliability.
- Note 2. Devices are ESD sensitive. Handling precaution recommended.
- **Note 3.** θ_{JA} is measured in the natural convection at T_A =25°C on a high effective thermal conductivity test board (40mm x 40mm x 1.6mm double sided board with 2oz, copper ratio: approx. 50%) of JEDEC 51-7 thermal measurement standard.
- Note 4. The device is not guaranteed to function outside its operating conditions.
- **Note 5.** The output current at which the output voltage becomes 95% of V_{OUT} after gradually increasing the output current.
- **Note 6.** The output current can be at least this value. Due to restrictions on the package power dissipation, this value may not be satisfied. Attention should be paid to the power dissipation of the package when the output current is large.

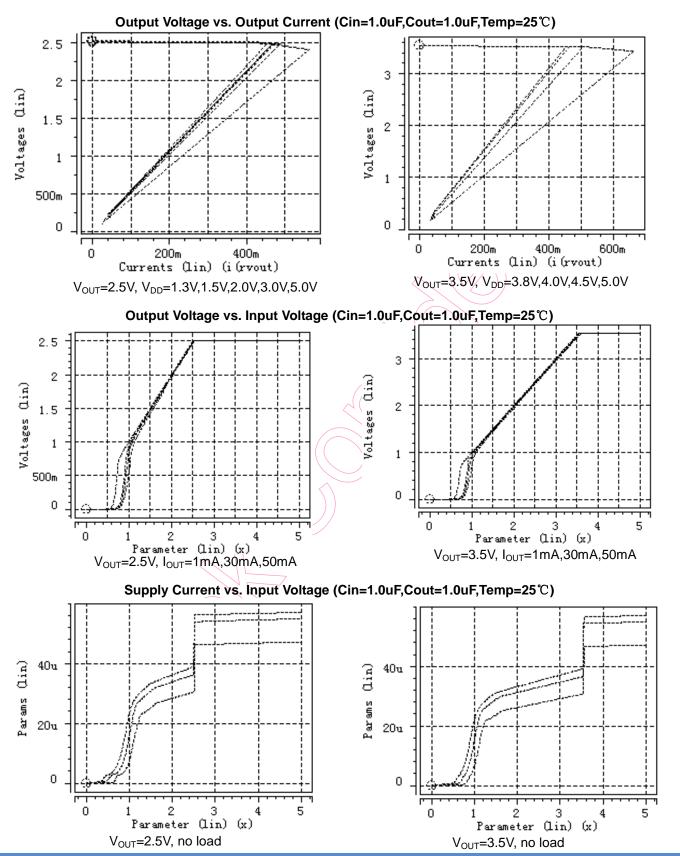
 The specification is guaranteed by design.
- **Note 7.** The dropout voltage is defined as $V_{IN} V_{OUT}$, which is measured when V_{OUT} is 98%* V_{OUT} .
- Note 8. The output voltage Auto discharge function is optional.



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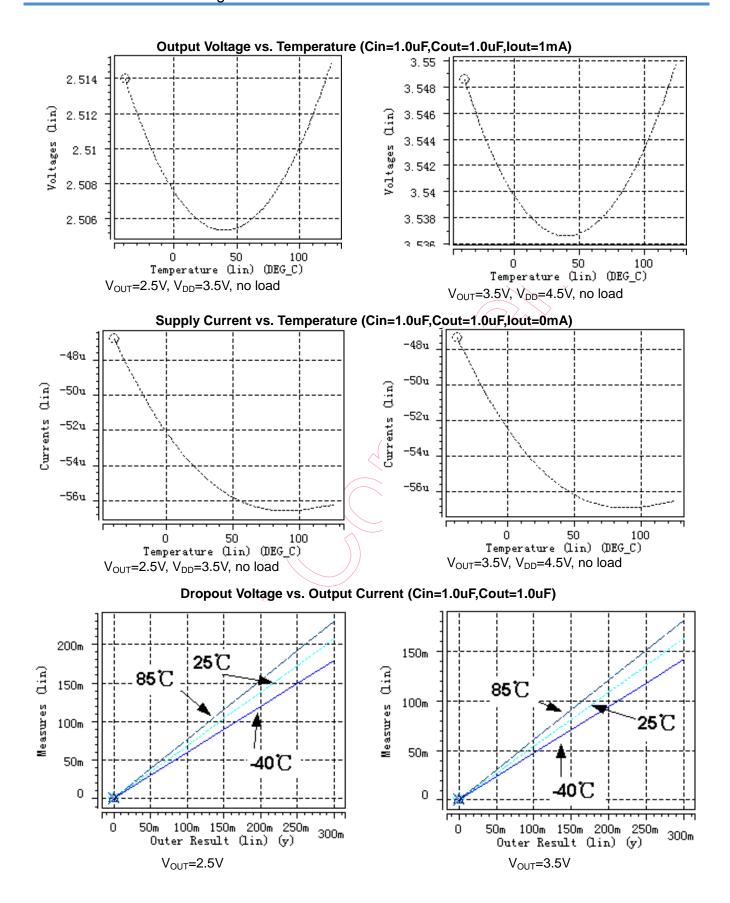
Typical Characteristics



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1kHz

10kHz

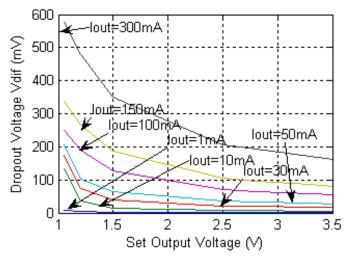
100kHz

6

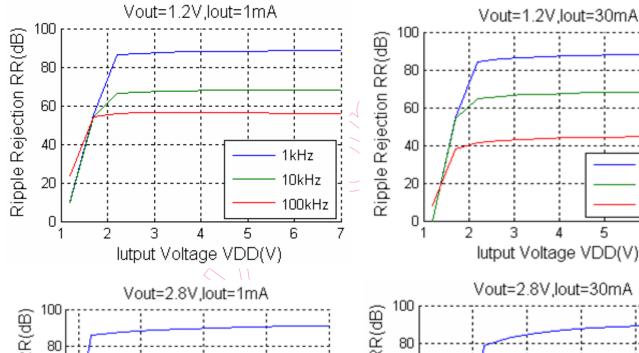
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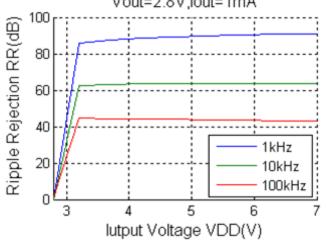
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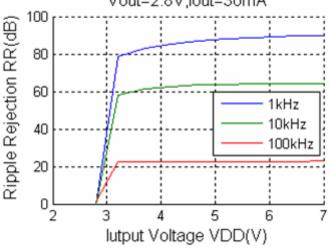




Ripple Rejection vs. Input Bias Voltage (Cin=none, Cout=1.0uF, Ripple=0.2Vp-p, Temp=25℃)

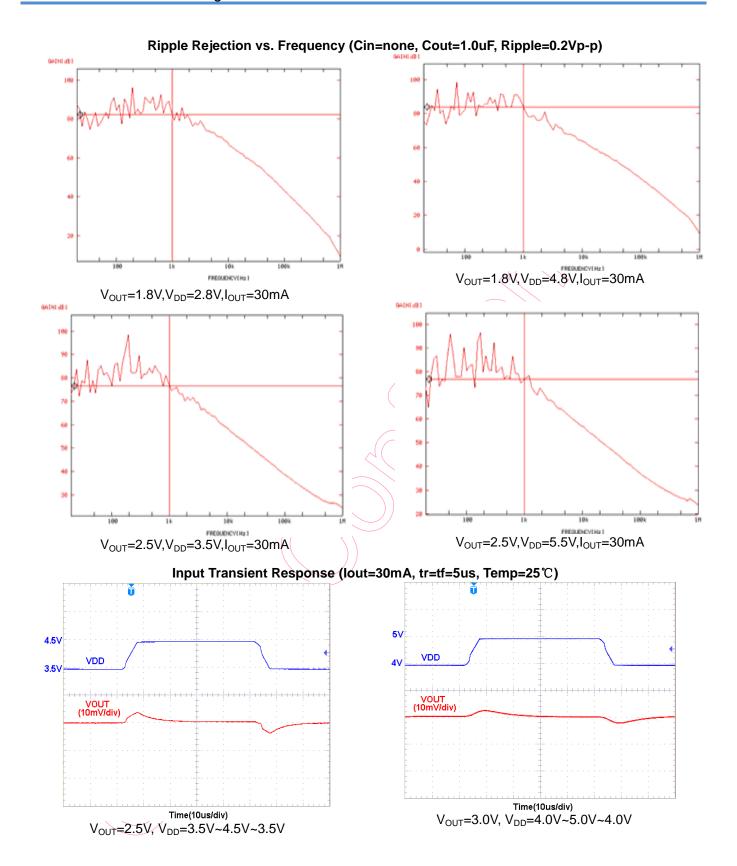






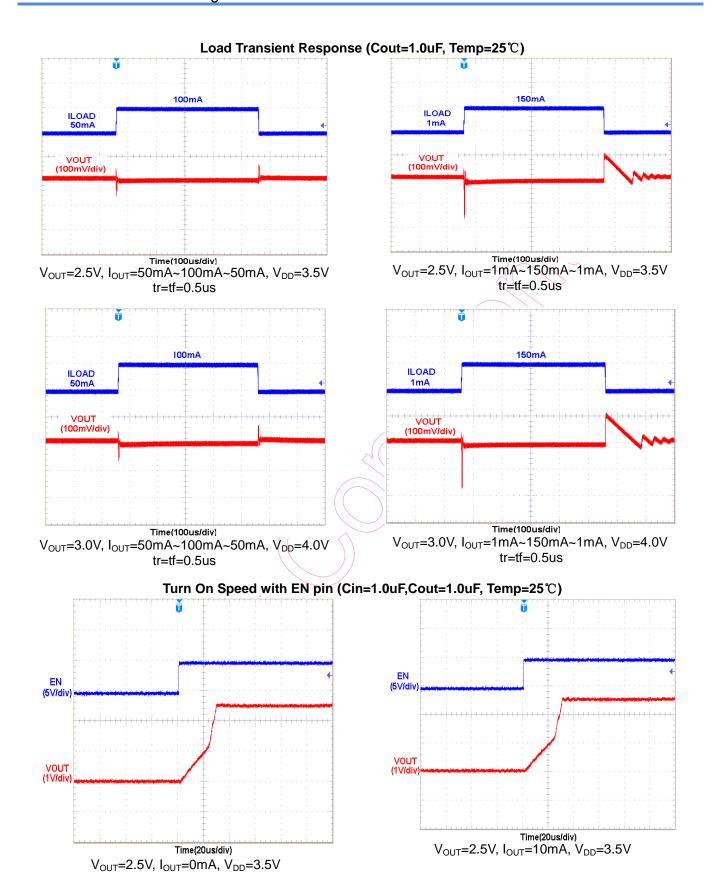
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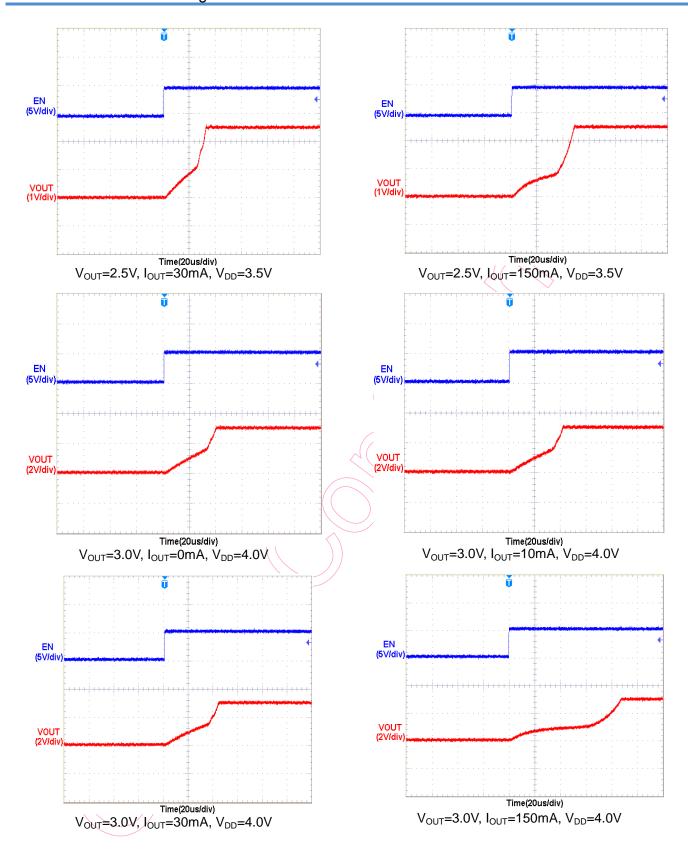
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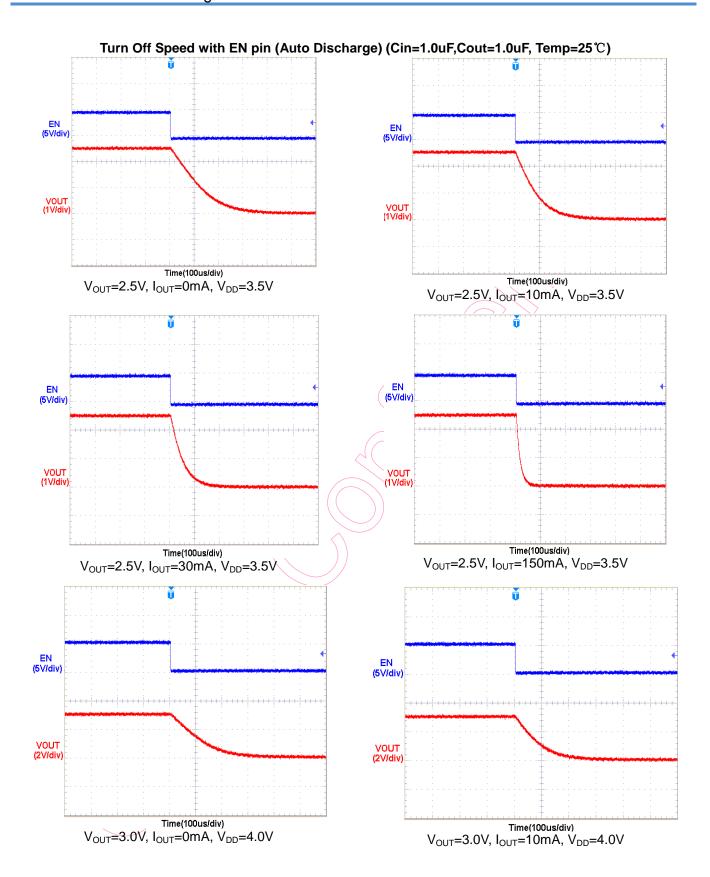
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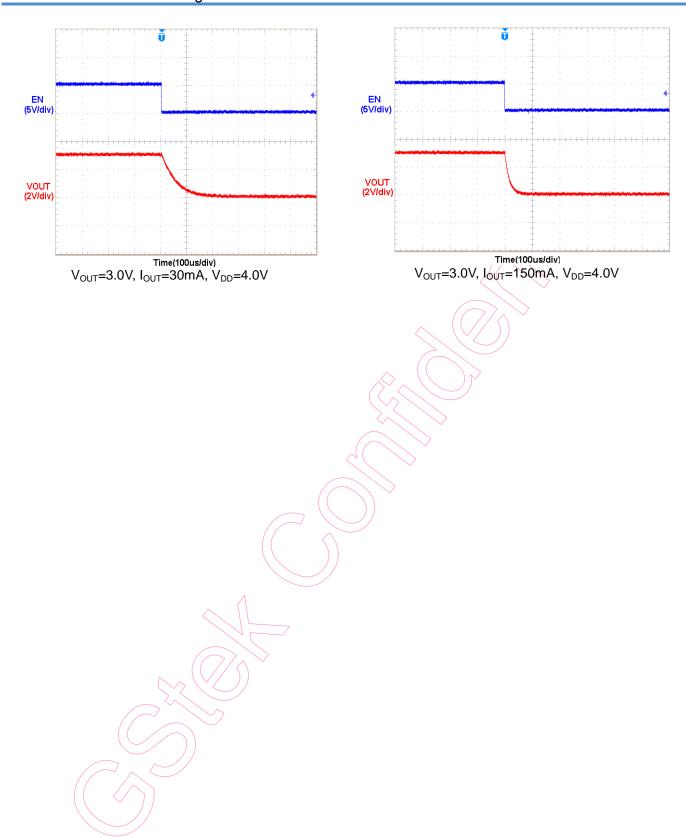
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Application Information

Enable

The GS7119 has a dedicated enable pin(EN). When the EN pin is in the logic low (V_{EN} <0.3V), the regulator will be turned off, reducing the supply current to less than 1uA.

When the EN pin is in the logic high ($V_{EN}>1.2V$), the regulator will be turned on. Left open, the EN pin is pulled down by a internal resistor to shut down the regulator.

Current Limit and Short circuit current protection

The GS7119 use a current mirror to monitor the output current. A small portion of the PMOS output transistor's current is mirrored onto a resistor such that the voltage across this resistor is proportional to the output current; this voltage is compared against the feedback voltage. Once the output current cannot exceeds the limit. The current is set to 480mA typically.

When the output voltage is less than 0.2V, the short circuit current protection starts and maintains the loading current to 40mA. The output can be shorted to ground without damaging the device.

Output Capacitor

The GS7119 is specifically designed to employ ceramic output capacitors as low as 1uF (X7R). The ceramic capacitors offer significant cost and space savings, along with high frequency noise filtering. Place the capacitors physically as close as possible to the device with wide and direct PCB traces.

Ceramic capacitors have different temperature characteristics and bias characteristics which depend on their dimensions and manufacturers. If the setting voltage is 2.5V or more and the capacitor's dimensions for V_{OUT} equal to 1.0mm by 0.5mm or smaller than that, the capacitance value might be extremely low. As a result, the capacitance might be much less than expected value. In such cases, the operation might be unstable at low temperature (-25°C or less). In that case, use a larger capacity, or a large dimensions' capacitor. (For example 1.6mm by 0.8mm)

Input Capacitor

Good bypassing is recommended from input to ground to help improve AC performance. A 1uF (X7R) input capacitor or greater located as close as possible to the IC is recommended. Place the capacitors physically as close as possible to the device with wide and direct PCB traces.

Power Dissipation and Layout Considerations

Excessive power dissipation may cause thermal overload, and hence the increase of the IC junction temperature beyond a safe operating level. For continuous operation, it is highly recommended to keep the junction temperature below the maximum operation junction temperature 125°C for maximum reliability.

The relationship between θ_{JA} and $T_{J(MAX)}$ can be calculated as:

$$P_{D(MAX)} = (T_{J(MAX)} - T_A) / \theta_{JA}$$

Where $T_{J(MAX)}$ is the maximum operation junction temperature 125°C, T_A is the ambient temperature and the θ_{JA} is the junction to ambient thermal resistance.

The power dissipation definition in device is:

$$P_{D} = (V_{IN} - V_{OUT}) \times I_{OUT} + V_{DD} \times I_{Q}$$

As the above equations indicate, it is desirable to

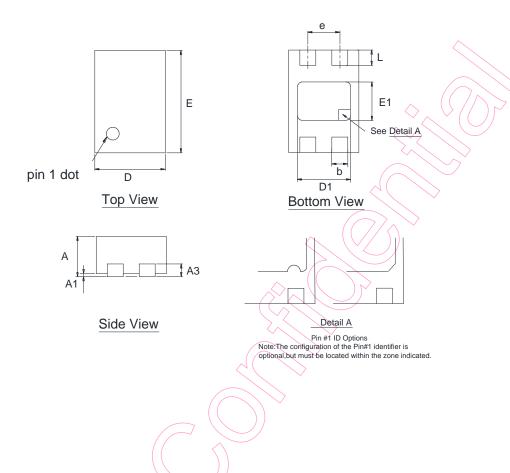
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work ICs whose θ_{JA} values are small such that $T_{J(MAX)}$ does not increase strongly with P_D . To avoid thermally overloading the GS7119, refrain from exceeding the absolute maximum junction temperature rating of 150°C under continuous operating condition. Overstressing the regulator with high loading currents and elevated input-to-output differential voltages can increase the IC die temperature significantly.





Package Dimensions, WDFN4-1.2x1.6



	Dimensions in				
Symbol	Millimeters				
1	Min.	Max.			
Α	0.45	0.55			
A1/	0.00	0.05			
A3	0.203 REF				
b	0.25	0.35			
е	0.60	REF.			
D	1.15	1.25			
E	1.55	1.65			
D1	1.00 REF.				
E1	0.70 REF.				
L	0.25	0.35			

Note:

1.Min.: Minimum dimension specified.2.Max.: Maximum dimension specified.

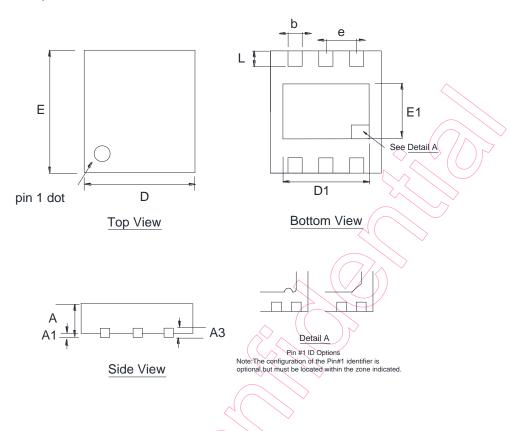
3.REF.: Reference. Normal/Regular dimension specified for reference.

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Package Dimensions, TDFN6-1.8x2



Symbol	Dimensions in Millimeters			
	Min.	Max.		
A	0.45	0.60		
A1	0.00	0.05		
A3	0.15 REF.			
∧ b	0.15	0.28		
е	0.50	REF.		
D	1.70	1.90		
E	1.90	2.10		
D1	1.45 REF.			
() E1	0.95 REF.			
// L	0.17	0.33		

Note:

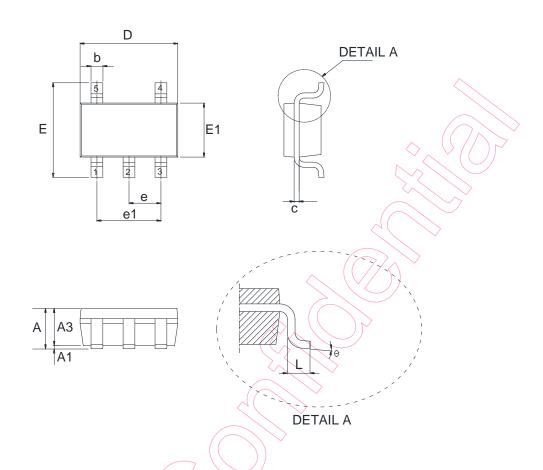
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Package Dimensions, SOT-23-5



Symbol	Dimensions in Millimeters				
	Min.	Max.			
Α	0.90	1.45			
_/ A1	0.00	0.15			
A3	0.90	1.30			
b	0.30	0.50			
С	0.08	0.25			
е	0.95 REF.				
e1	1.90 REF.				
// D	2.90	REF.			
E	2.80 REF.				
E1	1.60 REF.				
L	0.30	0.60			
θ	o°	8°			



1.Min.: Minimum dimension specified.

2.Max.: Maximum dimension specified.

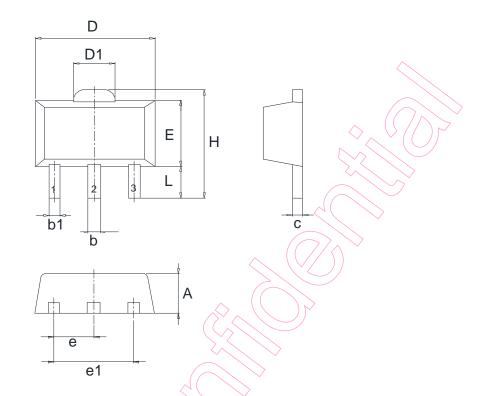
3.REF.: Reference. Normal/Regular dimension specified for reference.

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Package Dimensions, SOT-89-3



Symbol	Dimensions in Millimeters			
Cymbol				
	Min.	Max.		
Α	1.40	1.60		
b	0.40	0.58		
b1	0.32	0.52		
, C	0.35	0.44		
е	1.50 REF.			
e1	3.00	REF.		
D	4.40	4.60		
D1	1.60 REF.			
^ E	2.29	2.60		
)) H	3.94	4.25		
L	0.80	1.20		

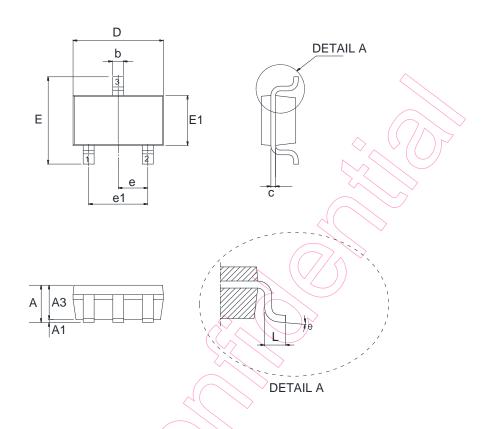
Note:

1.Min.: Minimum dimension specified.2.Max.: Maximum dimension specified.

3.REF.: Reference. Normal/Regular dimension specified for reference.



Package Dimensions, MSOT-23



		\		
C: made a L	Dimensions in Millimeters			
Symbol	IVIIIIII	ieters		
	Min.	Max.		
A	0.90	1.15		
A1	0,00	0.10		
A2	0.90	1.05		
∧ b	0.30 0.50			
С	0.08	0.15		
е	0.95 REF.			
e1	1.90	REF.		
Q	2.90	REF.		
E	2.40 REF.			
// E1	1.30 REF.			
L	0.30 0.50			
θ	o°	8°		

Note:

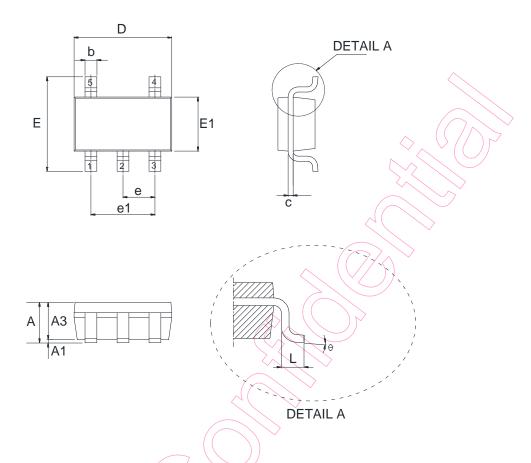
Min.: Minimum dimension specified.
 Max.: Maximum dimension specified.

3. REF.: Reference. Normal/Regular dimension specified for reference.

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Package Dimensions, SOT-353(SC-75)



	Dimensions in Millimeters	
Symbol		
	Min.	Max.
Α	0.85	1.10
A1	0.00	0.10
A3	0.80	1.00
b	0.15	0.35
	0.08	0.15
е	0.65 REF.	
e1	1.30 REF.	
) D	2.10 REF.	
/ E	2.30 REF.	
E1	1.25 REF.	
Ĺ	0.26	0.46
θ	0°	8°

Note:

1.Min.: Minimum dimension specified.

2.Max.: Maximum dimension specified.

3.REF.: Reference. Normal/Regular dimension specified for reference.

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M38D29FFHP#U1 702103A 717726C 742457H MP20051DN-LF-Z R5F111PGGFB#30 AP7363-SP-13 NCP103AMX285TCG
NCV8664CST33T3G NCV8752AMX28TCG L9454 AP7362-HA-7 LX13043CLD TCR3DF185,LM(CT TCR3DF24,LM(CT
TCR3DF285,LM(CT TCR3DF31,LM(CT TCR3DF45,LM(CT TLF4949EJ L9708 L970813TR 030014BB 059985X EAN61387601
EAN61573601 NCP121AMX173TCG NCP4687DH15T1G NCV8703MX30TCG 701326R 702087BB 755078E TCR2EN28,LF(S
LM1117DT-1.8/NO LT1086CM#TRPBF AZ1085S2-1.5TRE1 MAX15101EWL+T NCV8170AXV250T2G SCD337BTG
TCR3DF27,LM(CT TCR3DF19,LM(CT TCR3DF125,LM(CT TCR2EN18,LF(S MAX15103EWL+T TS2937CZ-5.0 C0 MAX8878EUK30-T MAX663CPA NCV4269CPD50R2G NCV8716MT30TBG AZ1117IH-1.2TRG1 MP2013GQ-P